

# **Film Capacitors**

# Metallized Polypropylene Film Capacitors (MKP)

Series/Type:B32613, B32614Date:September 2018

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#### Metallized polypropylene film capacitors (MKP)

#### High pulse (wound)

#### **Typical applications**

- Electronic ballasts
- Switch-mode power supplies

#### Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1:2013): 55/100/56

#### Construction

- Dielectric: polypropylene (PP)
- Wound capacitor technology
- Epoxy resin coating (UL 94 V-0)

#### Features

- Very high pulse strength
- RoHS-compatible

#### Terminals

- Crimped wire leads, lead-free tinned, lead length (6 – 1) mm
- Double crimped wire leads, lead-free tinned
- Straight wire leads, lead-free tinned, lead length (17 ±3) mm
- Different lead spacings (reduced and enlarged) available, lead length (6 -1) mm

#### Marking

Manufacturer's logo, style and type (P61x), rated capacitance (coded), capacitance tolerance (code letter), rated DC voltage, date of manufacture (code)

### **Delivery mode**

Bulk (untaped) Taped (Ammo pack or reel) For notes on taping, refer to chapter "Taping and packing". B32613, B32614

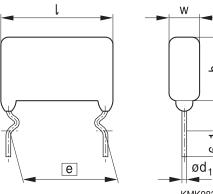


B32613, B32614 High pulse (wound)

# MKP

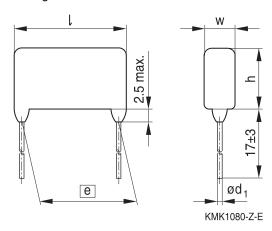
## Dimensional drawings

Crimped leads

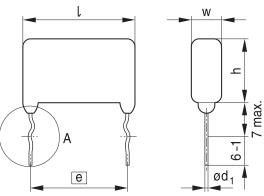


7 max. 6-1 ød<sub>1</sub> KMK0836-X-E

Straight leads

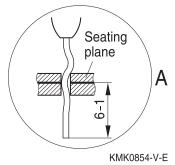


Double crimped leads



KMK0837-6-E

Detail of double crimped version



### **Dimensions in mm**

Lead spacing	Lead diameter	Туре
<i>e</i> ±0.8	d <sub>1</sub> ±0.05	
22.5	0.8	B32613
27.5	0.8	B32614



B32613, B32614

High pulse (wound)

## Overview of available types

Lead spacing	22.5 mm						
Туре	B32613						
Page	6						
V <sub>R</sub> (V DC)	250	400	630	1000	1600	2000	2000
V <sub>RMS</sub> (V AC)	160	200	250	250	500	700	1000
C <sub>R</sub> (nF)							
3.3							
4.7							
6.8							
10							
15							
22							
33							
47							
68							
100							
150							
220							
330							
470							
680							
1000							

## Lead configurations

Serie	Standard	Reduced	Enlarged	Straight	Double crimped
B32613	22.5 mm	15 / 17.5 / 20 mm	25 mm	22.5 mm	22.5 mm
B32614	27.5 mm	25 mm	-	27.5 mm	27.5 mm



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B32613, B32614 High pulse (wound)

## Overview of available types

Lead spacing	27.5 mm						
Туре	B32614						
Page	8						
V <sub>R</sub> (V DC)	250	400	630	1000	1600	2000	
V <sub>RMS</sub> (V AC)	160	200	250	250	500	700	
C <sub>R</sub> (nF)							
10							
15							
22							
33							
47							
68							
100							
150							
220							
470							
680							
1000							
1500							
2200							

## Lead configurations

Serie	Standard	Reduced	Enlarged	Straight	Double crimped
B32613	22.5 mm	15 / 17.5 / 20 mm	25 mm	22.5 mm	22.5 mm
B32614	27.5 mm	25 mm	_	27.5 mm	27.5 mm





B32613

High pulse (wound)

#### Ordering codes and packing units (lead spacing 22.5 mm)

V <sub>R</sub>	V <sub>RMS</sub>	C <sub>R</sub>	Max. dimensions	Ordering code	Ammo	Reel	Untaped
	f≤1 kHz		$w \times h \times I$	(composition see	pack		
V DC	V AC	nF	mm	below)	pcs./MOQ	pcs./MOQ	pcs./MOQ
250	160	220	$7.0\times14.5\times26.5$	B32613A3224+***	2000	2800	2000
		330	$7.0\times14.5\times26.5$	B32613A3334+***	2000	2800	2000
		470	$8.0\times15.5\times26.5$	B32613A3474+***	1800	2400	2000
		680	$9.5 \times 16.0 \times 26.5$	B32613A3684+***	1400	2000	2000
		1000	$11.0\times19.0\times26.5$	B32613A3105+***	1200	1800	1000
400	200	150	$7.0\times13.5\times26.5$	B32613A4154+***	2000	2800	2000
		220	$7.0\times14.0\times26.5$	B32613A4224+***	2000	2800	2000
		330	$8.0\times16.0\times26.5$	B32613A4334+***	1800	2400	2000
		470	$9.5\times16.0\times26.5$	B32613A4474+***	1400	2000	1000
		680	$11.5\times17.5\times26.5$	B32613A4684+***	1200	1600	1000
630	250	100	$7.0\times12.5\times26.5$	B32613A6104+***	2000	2800	1000
		150	$7.5\times14.0\times26.5$	B32613A6154+***	1800	2600	1000
		220	$9.0\times15.5\times26.5$	B32613A6224+***	1600	2200	1000
		330	$10.0\times18.0\times26.5$	B32613A6334+***	1400	2000	1000
		470	$11.0\times20.0\times26.5$	B32613A6474+***	1200	1800	1000
1000	250	33	$8.5\times14.5\times26.5$	B32613A0333+***	1600	2200	2000
		47	$10.0\times15.5\times26.5$	B32613A0473+***	1400	2000	1000
		68	$11.0\times17.5\times26.5$	B32613A0683+***	1200	1800	1000
		100	$10.0\times16.5\times26.5$	B32613A0104+***	1400	2000	1000
		150	$12.0\times18.0\times26.5$	B32613A0154+***	1200	1600	1000
1600	500	10	$7.0\times13.5\times26.5$	B32613A1103+***	2000	2800	2000
		15	$8.0\times14.5\times26.5$	B32613A1153+***	1800	2400	2000
		22	$9.0\times17.0\times26.5$	B32613A1223+***	1600	2200	1000
		33	$10.5\times18.5\times26.5$	B32613A1333+***	1400	1800	1000

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further E series and intermediate capacitance values on request.

#### Composition of ordering code

+ =	Capacitance tolerance code:
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 $K = \pm 10\%$ 

 $J = \pm 5\%$ 

\*\*\* = Packaging code:

- 289 = Ammo pack
- 189 = Reel
- 010 = Untaped crimped (lead length 6 -1 mm)
- 008 = Untaped straight (lead length 17±3 mm)
- 020 = Double crimped (lead length 6 -1 mm)

Packaging codes for further lead configurations (untaped):

Lead configuration (lead length 6 $-1$ mm)	Reduced	Reduced	Reduced	Enlarged
Lead spacing (mm)	15 mm	17.5 mm	20 mm	25 mm
Packaging code	055	060	070	080



High pulse (wound)

B32613



### Ordering codes and packing units (lead spacing 22.5 mm)

V <sub>R</sub>	V <sub>RMS</sub>	C <sub>R</sub>	Max. dimensions	Ordering code	Ammo	Reel	Untaped
	f≤1 kHz		$w \times h \times I$	(composition see	pack		
V DC	V AC	nF	mm	below)	pcs./MOQ	pcs./MOQ	pcs./MOQ
2000	700	3.3	$7.0\times13.0\times26.5$	B32613A2332+***	2000	2800	2000
		4.7	$7.5 \times 14.0 \times 26.5$	B32613A2472+***	1800	2600	2000
		6.8	$8.5\times16.0\times26.5$	B32613A2682+***	1600	2200	2000
		10	$10.5\times17.0\times26.5$	B32613A2103+***	1400	1800	1000
		15	$12.0\times20.5\times26.5$	B32613A2153+***	1200	1600	1000
2000	1000	3.3	$8.0\times14.5\times26.5$	B32613A8332+***	1800	2400	2000
		4.7	$8.5\times16.5\times26.5$	B32613A8472+***	1600	2200	1000
		6.8	$10.0\times18.5\times26.5$	B32613A8682+***	1400	2000	1000
		10	$11.5\times21.5\times26.5$	B32613A8103+***	1200	1600	1000

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further E series and intermediate capacitance values on request.

#### Composition of ordering code

- + = Capacitance tolerance code:
  - K = ±10%
  - $J = \pm 5\%$

\*\*\* = Packaging code:

289 = Ammo pack

189 = Reel

010 = Untaped crimped (lead length 6 -1 mm)

008 = Untaped straight (lead length 17±3 mm)

020 = Double crimped (lead length 6 -1 mm)

Packaging codes for further lead configurations (untaped):

Lead configuration (lead length 6 $-1$ mm)	Reduced	Reduced	Reduced	Enlarged
Lead spacing (mm)	15 mm	17.5 mm	20 mm	25 mm
Packaging code	055	060	070	080





B32614

High pulse (wound)

#### Ordering codes and packing units (lead spacing 27.5 mm)

V <sub>R</sub>	V <sub>RMS</sub>	C <sub>R</sub>	Max. dimensions	Ordering code	Untaped
	f ≤1 kHz		$w \times h \times l$	(composition see below)	
V DC	V AC	nF	mm		pcs./MOQ
250	160	470	$7.0\times15.0\times31.5$	B32614A3474+***	2000
		680	$8.0\times16.5\times31.5$	B32614A3684+***	2000
		1000	$9.5\times17.5\times31.5$	B32614A3105+***	800
		1500	$11.5\times19.5\times31.5$	B32614A3155+***	800
		2200	$14.0\times22.0\times31.5$	B32614A3225+***	800
400	200	470	$9.5 \times 15.0 \times 31.5$	B32614A4474+***	800
		680	$10.0\times17.5\times31.5$	B32614A4684+***	800
		1000	$11.5\times19.5\times31.5$	B32614A4105+***	800
		1500	$14.0\times22.0\times31.5$	B32614A4155+***	800
		2200	$16.5\times24.5\times31.5$	B32614A4225+***	600
630	250	470	$10.5\times18.5\times31.5$	B32614A6474+***	800
		680	$12.0\times21.5\times31.5$	B32614A6684+***	800
		1000	$14.0\times24.0\times31.5$	B32614A6105+***	800
1000	250	100	$11.5\times17.5\times31.5$	B32614A0104+***	2000
		150	$13.0\times21.0\times31.5$	B32614A0154+***	800
		220	$14.5\times24.5\times31.5$	B32614A0224+***	800
1600	500	22	$9.0\times14.5\times31.5$	B32614A1223+***	2000
		33	$10.5\times16.0\times31.5$	B32614A1333+***	2000
		47	$11.0\times19.5\times31.5$	B32614A1473+***	800
		68	$13.0\times21.5\times31.5$	B32614A1683+***	800
2000	700	10	$9.0\times15.5\times31.5$	B32614A2103+***	2000
		15	$11.0\times17.5\times31.5$	B32614A2153+***	800
		22	$13.0\times19.5\times31.5$	B32614A2223+***	800
		33	$14.5\times23.0\times31.5$	B32614A2333+***	800
		47	$16.5\times25.5\times31.5$	B32614A2473+***	600

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further E series and intermediate capacitance values on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

- $K = \pm 10\%$
- $J = \pm 5\%$

\*\*\* = Packaging code:

010 = Untaped crimped (lead length 6 -1 mm)

008 = Untaped straight (lead length 17±3 mm)

020 = Double crimped (lead length 6 -1 mm)

Packaging codes for further lead configurations (untaped):

Lead configuration (lead length 6 -1 mm)	Reduced
Lead spacing (mm)	25 mm
Packaging code	090



B32613, B32614

High pulse (wound)



## **Technical data**

Reference standard: IEC 60384-16:2005. All data given at T = 20  $^{\circ}$ C, unless otherwise specified.

	10.2000.70		. g	,		normoo opoomoa.
Operating temperature range	Max. operating temperature T <sub>op,max</sub> +110 °C					
	Upper category temperature T <sub>max</sub> +100 °C					
	Lower category temperature T <sub>min</sub> -55 °C			C		
	Rated temperature T <sub>R</sub> +85 °C			C		
Dissipation factor $tan \delta$ (in 10 <sup>-3</sup> )	at	C <sub>R</sub> ≤	Ω.1 μF	$0.1 \ \mu F < C_R \le$	≤1 μF	C <sub>R</sub> > 1 μF
at 20 °C (upper limit values)	1 kHz	_		0.5		0.5
	10 kHz	—		0.8		1.5
	100 kHz	5.0		—		-
Insulation resistance R <sub>ins</sub>	$C_{\text{R}} \leq 0.33~\mu$	F	$C_R > 0$	33 μF		·
or time constant $\tau = C_R \cdot R_{ins}$	100 GΩ		30000	S		
at 20 °C, rel. humidity $\leq$ 65%						
(minimum as-delivered values)						
DC test voltage	1.6 · V <sub>R</sub> , 2 s	S				
Category voltage V <sub>c</sub>	T <sub>op</sub> (°C)	DC	voltage	derating	AC voltage derating	
(continuous operation with	$T_{op} \le 85$	Vc	= V <sub>R</sub>		$V_{C,RMS} = V_{RMS}$	
$V_{DC}$ or $V_{AC}$ at f $\leq$ 1 kHz)	85 <t<sub>op≤100</t<sub>	Vc	$= V_R \cdot (1)^2$	165-T <sub>op</sub> )/80	$V_{C,RMS} = V_{RMS} \cdot (165 - T_{op})/80$	
Operating voltage $V_{op}$ for	T <sub>op</sub> (°C)		•	(max. hours)		
short operating periods	$T_{op} \leq 100$ $V_{op} = 1.25$ ·		V <sub>c</sub> (2000 h)	$V_{op} = 1.0$	0 · V <sub>C,RMS</sub> (2000 h)	
$(V_{DC} \text{ or } V_{AC} \text{ at } f \le 1 \text{ kHz})$	$100 < T_{op} \le 110$ V <sub>op</sub> = 1.25 · V <sub>C</sub> (1)		V <sub>c</sub> (1000 h)	$V_{op} = 1.0$	0 · V <sub>C,RMS</sub> (1000 h)	
Reliability:						
Failure rate $\lambda$	1 fit (≤ 1 · 1	0 <sup>-9</sup> /h	) at 0.5	• V <sub>R</sub> , 40 °C		
Service life t <sub>SL</sub>	200 000 h a	t 1.0	• V <sub>R</sub> , 85	5 °C		
	For convers	sion t	o other o	operating cond	ditions ar	nd temperatures,
	refer to cha	pter '	'Quality,	2 Reliability".		
Failure criteria:						
Total failure	Short circuit	t or o	pen circ	uit		
Failure due to variation	Capacitance	e cha	$\log  \Delta 0$	C/C	> 10%	
of parameters	Dissipation				•	per limit value
	Insulation re					MΩ (C <sub>R</sub> ≤0.33 μF)
	or time cons	stant	$\tau = C_R \cdot$	R <sub>ins</sub>	< 500 s	(C <sub>R</sub> >0.33 μF)

## Characteristic voltages $V_{\mbox{\tiny DC}},\,V_{\mbox{\tiny AC}},\,V_{\mbox{\tiny pp}}$

V <sub>DC</sub>	V <sub>AC</sub>	V <sub>pp</sub>
V	V	V
1000	250	700
1250	500	1250
1600	500	1400
1600	700	1600
2000	700	1600
2000	1000	2000



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## B32613, B32614

High pulse (wound)

## Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in  $V/\mu s$ .

" $k_0$ " represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V<sup>2</sup>/µs.

### Note:

The values of dV/dt and  $k_0$  provided below must not be exceeded in order to avoid damaging the capacitor. These parameters are given for isolated pulses in such a way that the heat generated by one pulse will be completely dissipated before applying the next pulse. For a train of pulses, please refer to the curves of permissible AC voltage-current versus frequency.

### dV/dt values

Lead spac	ing	22.5 mm	27.5 mm	
V <sub>R</sub>	V <sub>RMS</sub>			
V DC	V AC	dV/dt in V/µs		
250	160	120	50	
400	200	180	100	
630	250	300	150	
1000	250	600	300	
1250	500	1150	600	
1600	500	2400	1000	
1600	700	-	-	
2000	700	7000	2300	
2000	1000	7500	_	

#### k<sub>0</sub> values

Lead space	cing	22.5 mm	27.5 mm	
V <sub>R</sub>	V <sub>RMS</sub>	·	· · ·	
V DC	V AC	k₀ in V²/μs		
250	160	60 000	25 000	
400	200	200 000	110 000	
630	250	350 000	250 000	
1000	250	1 500 000	1 000 000	
1250	500	3 750 000	2 000 000	
1600	500	10 000 000	4 000 000	
1600	700	-	_	
2000	700	40 000 000	15 000 000	
2000	1000	50 000 000	_	

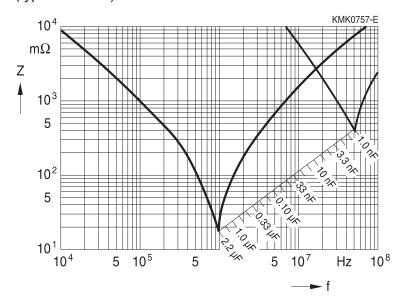




## B32613, B32614 High pulse (wound)

## Impedance Z versus frequency f

(typical values)







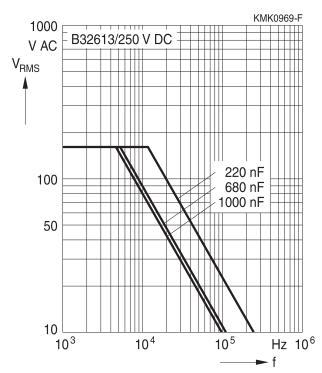
## B32613 High pulse (wound)

## Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, $T_A \leq 90$ °C)

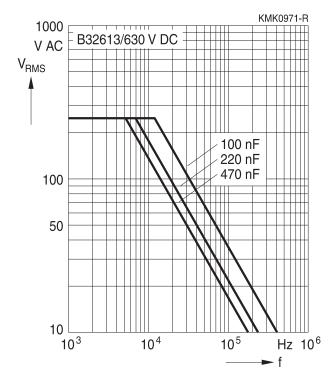
For  $T_A > 90$  °C, please use derating factor  $F_T$ .

### Lead spacing 22.5 mm

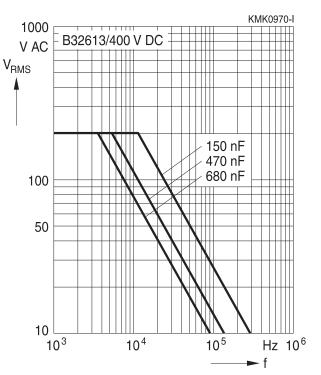
250 V DC/160 V AC

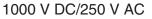


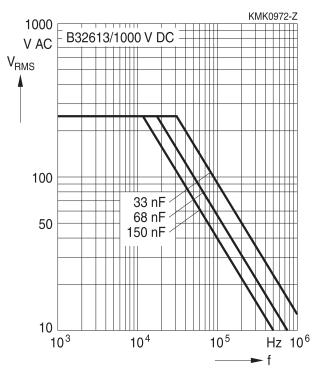
630 V DC/250 V AC



400 V DC/200 V AC









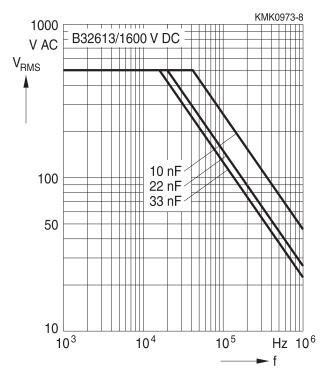


## Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>A</sub> $\leq$ 90 °C)

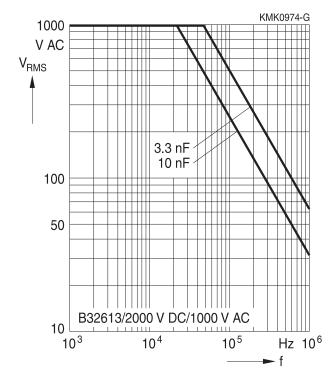
For  $T_A > 90$  °C, please use derating factor  $F_T$ .

## Lead spacing 22.5 mm

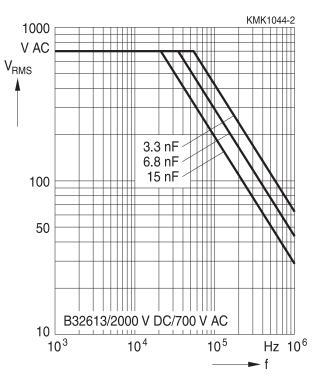
1600 V DC/500 V AC



2000 V DC/1000 V AC



2000 V DC/700 V AC







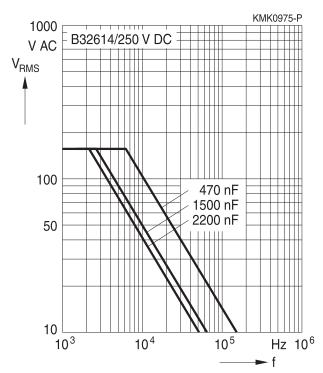
B32614 High pulse (wound)

## Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, $T_A \leq 90$ °C)

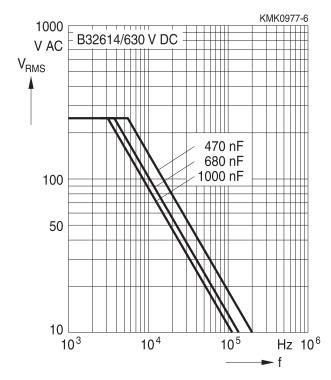
For  $T_A > 90 \,^{\circ}C$ , please use derating factor  $F_T$ .

### Lead spacing 27.5 mm

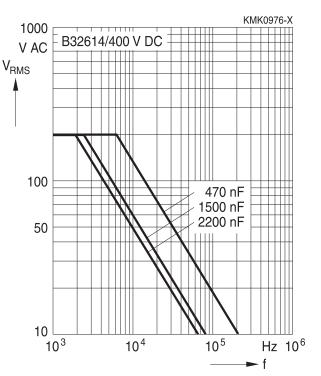
250 V DC/160 V AC

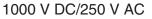


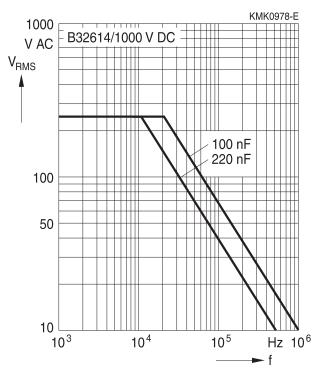
630 V DC/250 V AC



400 V DC/200 V AC







Please read *Cautions and warnings* and *Important notes* at the end of this document.



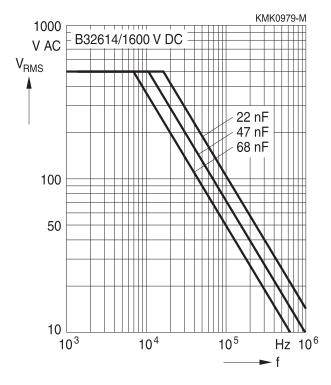


## Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>A</sub> $\leq$ 90 °C)

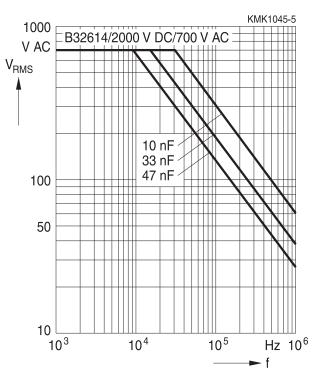
For  $T_A > 90$  °C, please use derating factor  $F_T$ .

## Lead spacing 27.5 mm

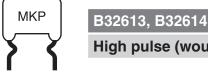
1600 V DC/500 V AC



#### 2000 V DC/700 V AC







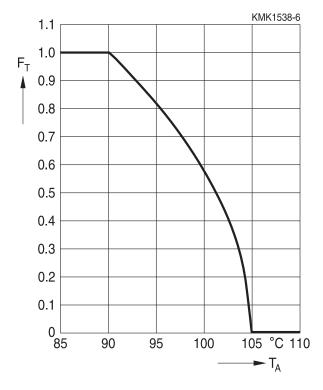
High pulse (wound)

## Maximum AC voltage (V<sub>RMS</sub>), current (I<sub>RMS</sub>) versus frequency and temperature for T<sub>A</sub> >90 °C

The graphs described in the previous section for the permissible AC voltage (V<sub>RMS</sub>) or current  $(I_{RMS})$  versus frequency are given for a maximum ambient temperature  $T_A \leq 90$  °C. In case of higher ambient temperatures (T<sub>A</sub>), the self-heating ( $\Delta$ T) of the component must be reduced to avoid that temperature of the component (T<sub>op</sub>= T<sub>A</sub> +  $\Delta$ T) reaches values above maximum operating temperature. The factor  $F_T$  shall be applied in the following way:

 $I_{RMS}(T_A) = I_{RMS,T_A \leq 90 \ ^{\circ}C} \cdot F_T(T_A)$  $V_{RMS}(T_A) = V_{RMS,T_A \leq 90 \circ C} \cdot F_T(T_A)$ 

And  $F_{T}$  is given by the following curve:





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## **Testing and Standards**

Test	Reference	Conditions of test		Performance requirements
Electrical parameters	IEC 60384-16:2005	Voltage proof, 1.6 $V_R$ , 1 minute Insulation resistance, $R_{ins}$ Capacitance, C Dissipation factor, tan $\delta$		Within specified limits
Robustness of termina- tions	IEC 60068-2-21:2006		Ua1) ensile force 0 N	Capacitance and tan $\delta$ within specified limits
Resistance to soldering heat	IEC 60068-2-20:2008, test Tb, method 1A	Solder bath temperat immersion for 10 seco		$\begin{array}{l} \Delta C/C_0 \leq 2\% \\  \Delta \ tan \ \delta  \leq 0.002 \end{array}$
Rapid change of temperature	IEC 60384-16:2005	$T_A$ = lower category temperature $T_B$ = upper category temperature Five cycles, duration t = 30 min.		$\begin{split}  \Delta C/C_0  &\leq 2\% \\  \Delta \tan \delta  &\leq 0.002 \\ R_{\text{ins}} &\geq 50\% \text{ of initial limit} \end{split}$
Vibration	IEC 60384-16:2005	Test $F_c$ : vibration sinusoidal Displacement: 0.75 mm Accleration: 98 m/s <sup>2</sup> Frequency: 10 Hz 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe		No visible damage
Bump	IEC 60384-16:2005	390 m/s <sup>2</sup> mounted on PCB Duration: 6 ms		No visible damage $ \Delta C/C_0  \le 2\%$ $ \Delta \tan \delta  \le 0.002$ $R_{ins} \ge 50\%$ of initial limit
Climatic sequence	IEC 60384-16:2005	Dry heat Tb / 16 h Damp heat cyclic, 1 <sup>st</sup> cycle +55 °C / 24 h / 95% 100% RH Cold Ta / 2 h Damp heat cyclic, 5 cycles +55 °C / 24 h / 95% 100% RH		No visible damage $ \Delta C/C_0  \le 3\%$ $ \Delta \tan \delta  \le 0.001$ $R_{ins} \ge 50\%$ of initial limit
Damp heat, steady state	IEC 60384-16:2005	Test Ca 40 °C / 93% RH / 56 days		$\begin{split} & \text{No visible damage} \\ &  \Delta C/C_0  \leq 3\% \\ &  \Delta \tan \delta  \leq 0.001 \\ & \text{R}_{\text{ins}} \geq 50\% \text{ of initial limit} \end{split}$
Endurance A	IEC 60384-16:2005	85 °C / 1.25 V <sub>R</sub> / 2000 hours		No visible damage $\begin{split}  \Delta C/C_0  &\leq 5\% \\  \Delta \ tan \ \delta  &\leq 0.002 \\ R_{\text{ins}} &\geq 50\% \ \text{of initial limit} \end{split}$





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Test	Reference	Conditions of test	Performance requirements
Endurance B	IEC 60384-16:2005	100 °C / 1.25 V <sub>c</sub> / 2000 hours	No visible damage $ \Delta C/C_0  \le 5\%$ $ \Delta \tan \delta  \le 0.002$ $R_{ins} \ge 50\%$ of initial limit

### **Mounting guidelines**

## 1 Soldering

## 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder $\ge$ 90%, free-flowing solder



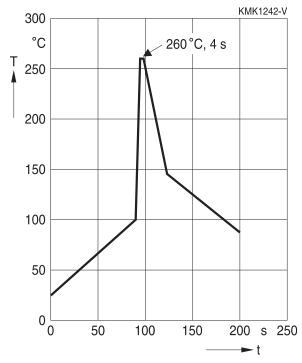
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## 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1. Conditions:

Serie	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP			
MKP	(lead spacing >7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP	(lead spacing ≤7.5 mm)		<4 s
MKT	uncoated (lead spacing ≤10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing $\leq$ 10 mm) and insulated (B32559)



Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 $\pm$ 0.5) mm thick, between
	capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
	2% for MKT/MKP/MFP
$\Delta C/C_0$	5% for EMI suppression capacitors
tan δ	As specified in sectional specification



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## 1.3 General notes on soldering

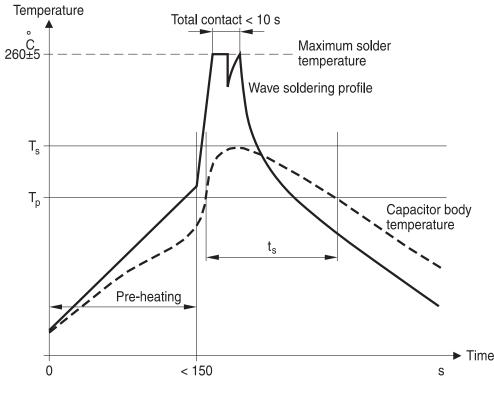
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
  - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

### Recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:



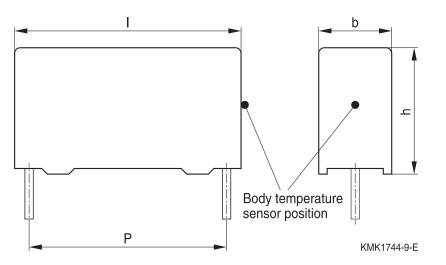
Ts: Capacitor body maximum temperature at wave soldering

T<sub>p</sub>: Capacitor body maximum temperature at pre-heating



MKP

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Body temperature should follow the description below:

- MKP capacitor During pre-heating: T<sub>p</sub> ≤110 °C During soldering: T<sub>s</sub> ≤120 °C, t<sub>s</sub> ≤45 s
- MKT capacitor During pre-heating: T<sub>p</sub> ≤125 °C During soldering: T<sub>s</sub> ≤160 °C, t<sub>s</sub> ≤45 s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T<sub>s</sub>) must be  $\leq$ 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings  $\leq$ 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.



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## **Cautions and warnings**

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



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Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

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## Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α <sub>c</sub>	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β <sub>c</sub>	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C <sub>R</sub>	Rated capacitance	Nennkapazität
$\Delta C$	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
$\Delta T$	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f <sub>1</sub>	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f <sub>2</sub>	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f <sub>r</sub>	Resonant frequency	Resonanzfrequenz
F <sub>D</sub>	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F <sub>τ</sub>	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I <sub>C</sub>	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



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Symbol	English	German
I <sub>RMS</sub>	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
i <sub>z</sub>	Capacitance drift	Inkonstanz der Kapazität
k <sub>o</sub>	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
$\lambda_{0}$	Constant failure rate during useful service life	Konstante Ausfallrate in der
2		Nutzungsphase
λ <sub>test</sub>	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P <sub>diss</sub>	Dissipated power	Abgegebene Verlustleistung
P <sub>gen</sub>	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R <sub>i</sub>	Internal resistance	Innenwiderstand
<b>R</b> <sub>ins</sub>	Insulation resistance	Isolationswiderstand
$R_P$	Parallel resistance	Parallelwiderstand
R <sub>s</sub>	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$tan \; \delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan $\delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan $\delta_s$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T <sub>A</sub>	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T <sub>max</sub>	Upper category temperature	Obere Kategorietemperatur
T <sub>min</sub>	Lower category temperature	Untere Kategorietemperatur
t <sub>OL</sub>	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
$T_{op}$	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T <sub>R</sub>	Rated temperature	Nenntemperatur
T <sub>ref</sub>	Reference temperature	Referenztemperatur
t <sub>SL</sub>	Reference service life	Referenz-Lebensdauer



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Symbol	English	German
V <sub>AC</sub>	AC voltage	Wechselspannung
V <sub>c</sub>	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
$V_{\text{DC}}$	DC voltage	Gleichspannung
$V_{\text{FB}}$	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
$V_{op}$	Operating voltage	Betriebsspannung
V <sub>p</sub>	Peak pulse voltage	Impuls-Spitzenspannung
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
V <sub>R</sub>	Rated voltage	Nennspannung
ν <sub>R</sub>	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
$V_{RMS}$	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
$V_{SC}$	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{sn}$	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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